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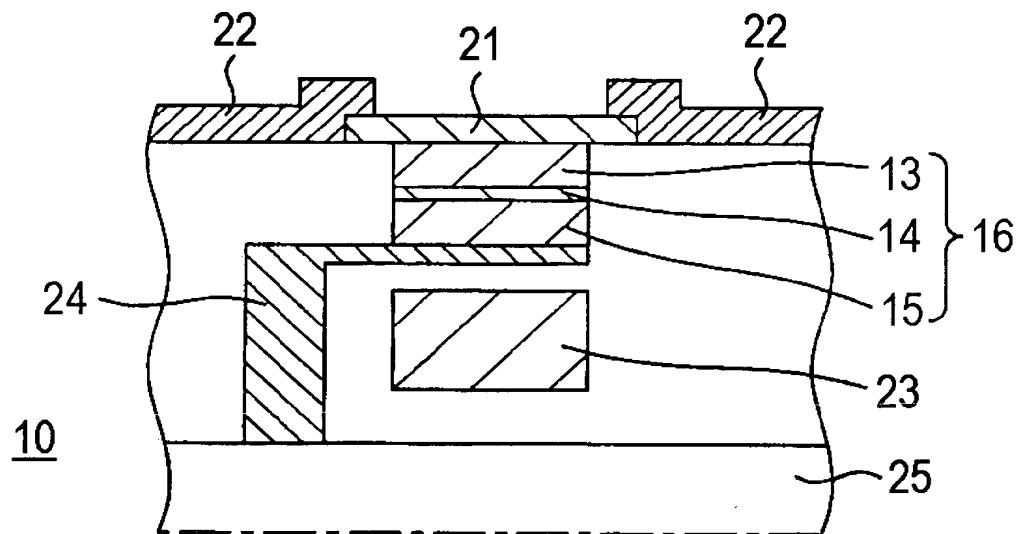
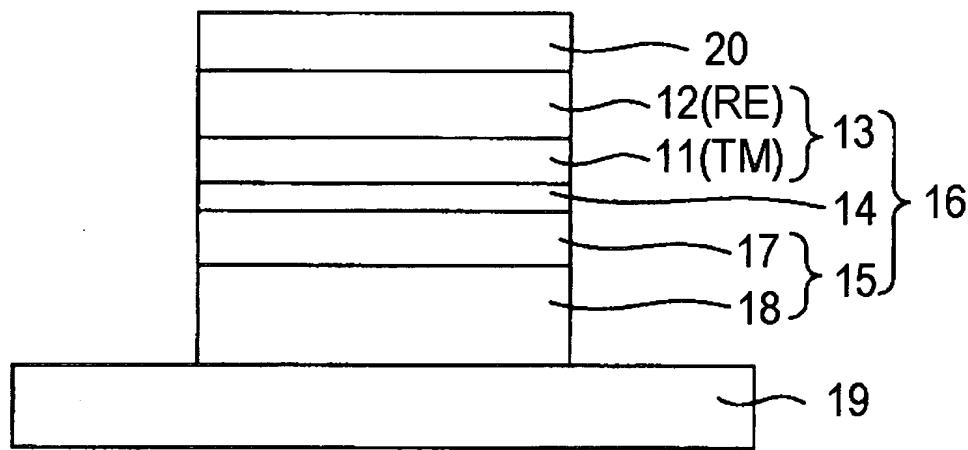
FIG.1**FIG.2**

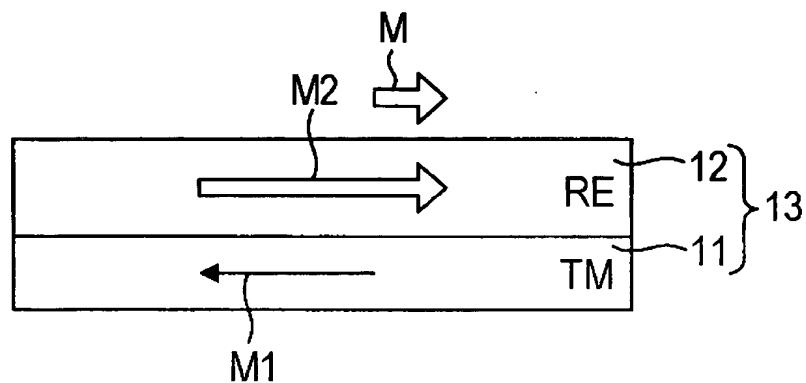
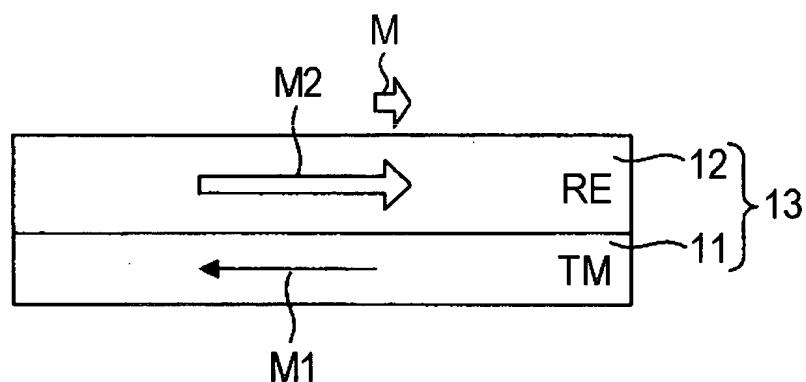
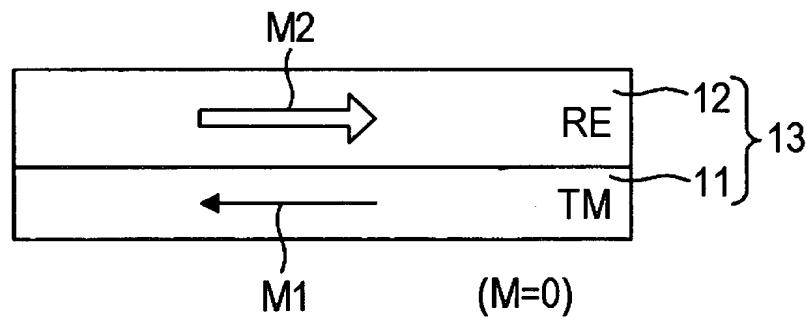
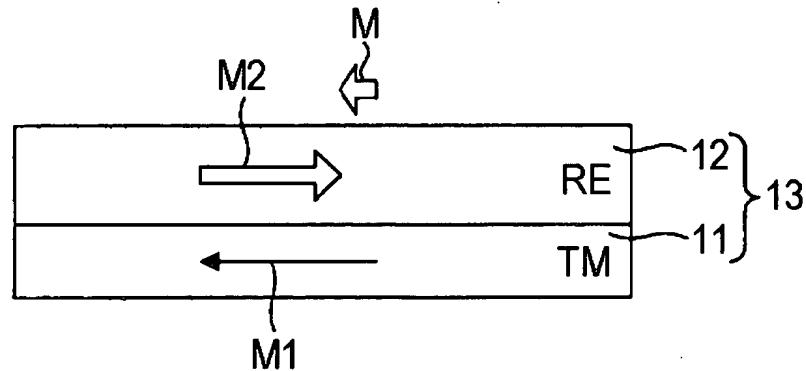
FIG.3A**FIG.3B****FIG.3C****FIG.3D**

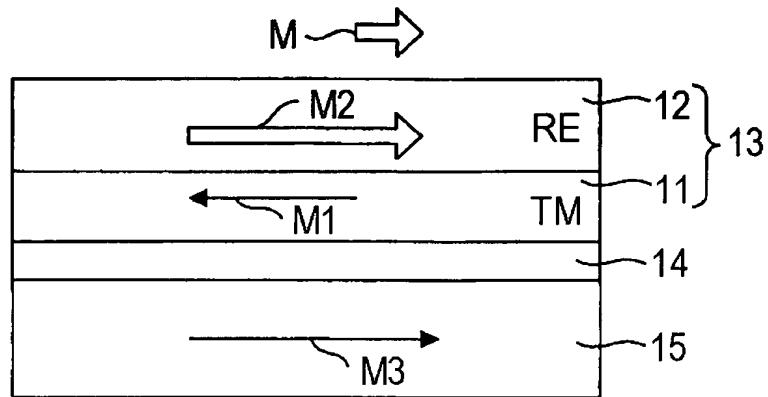
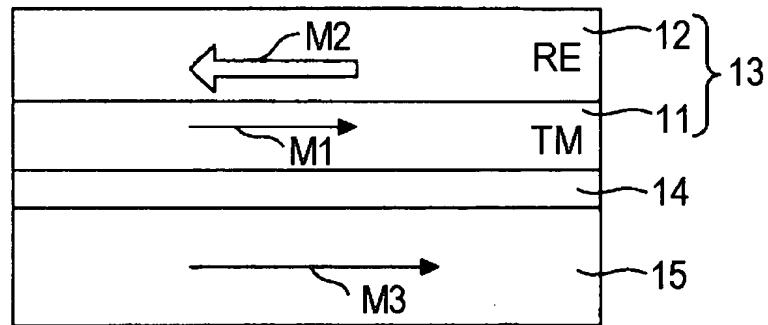
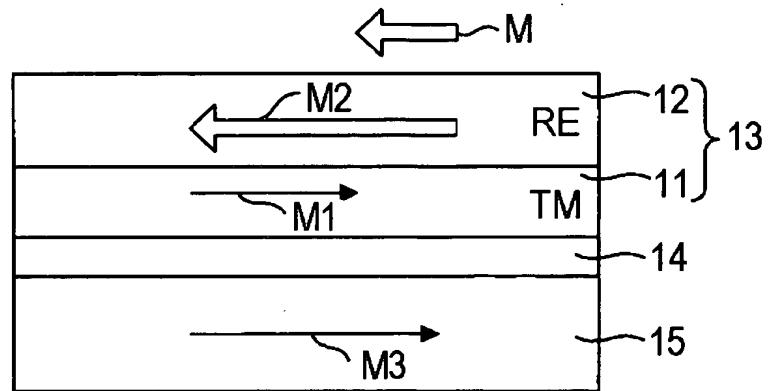
FIG.4A**FIG.4B****FIG.4C**

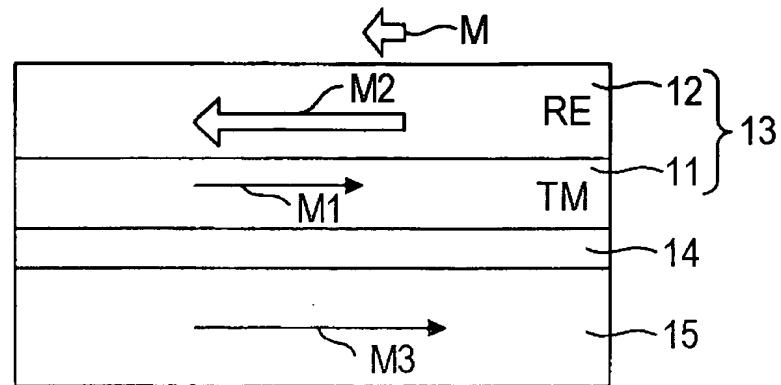
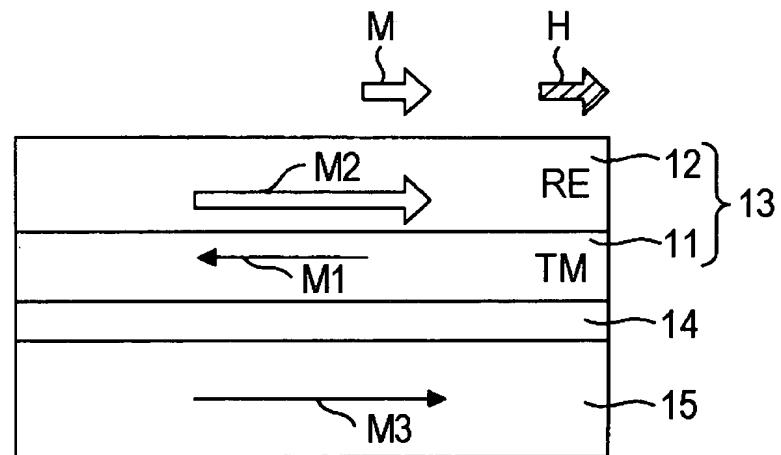
FIG.5A**FIG.5B**

FIG.6

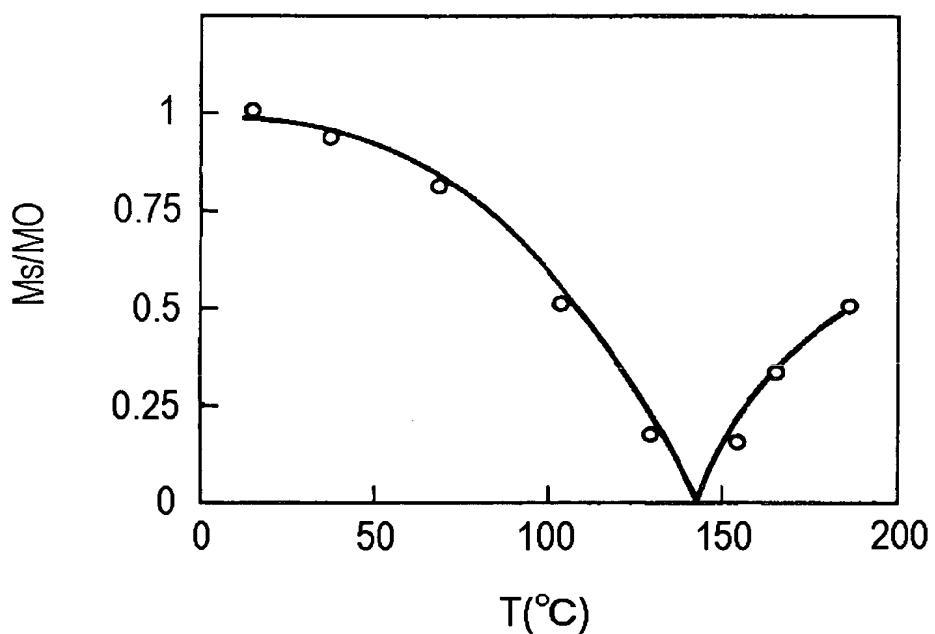


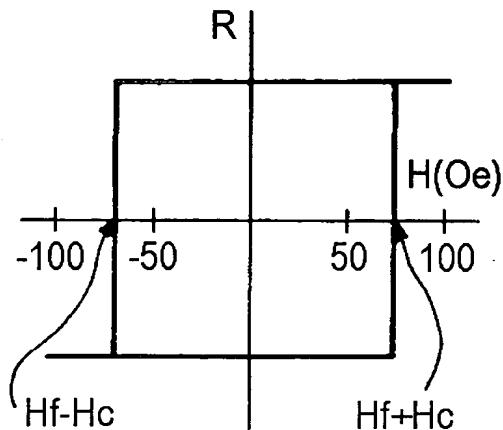
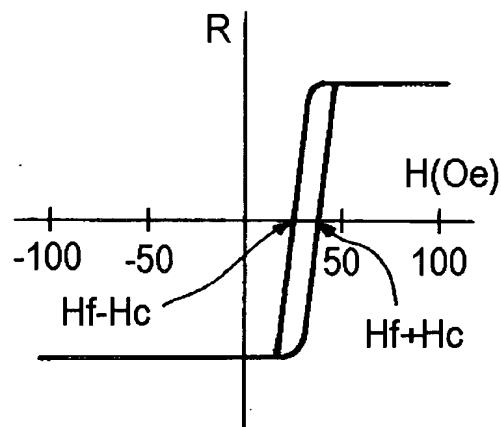
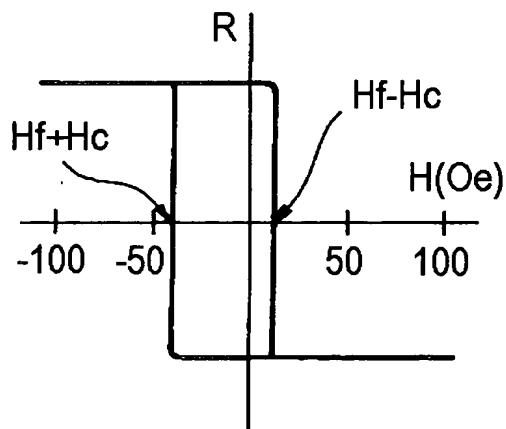
FIG.7A**FIG.7B****FIG.7C**

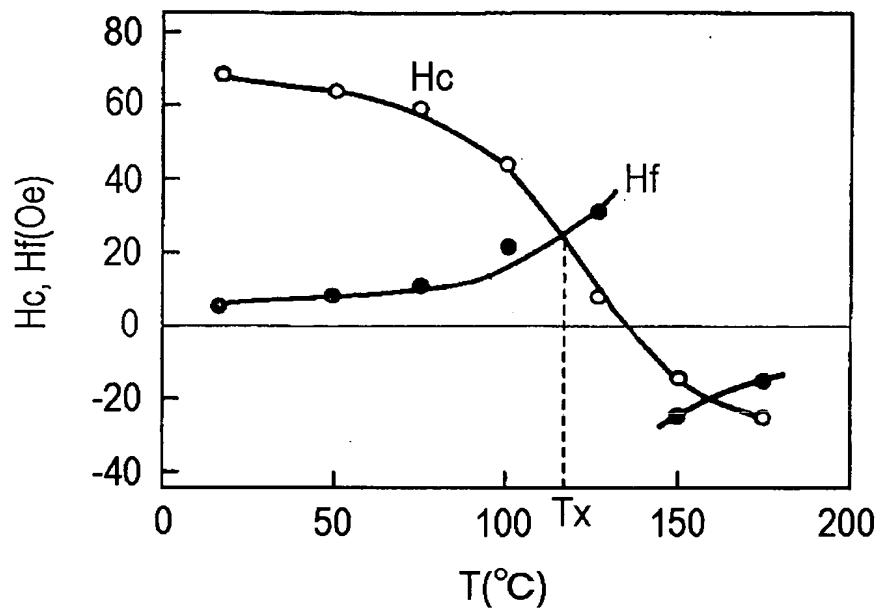
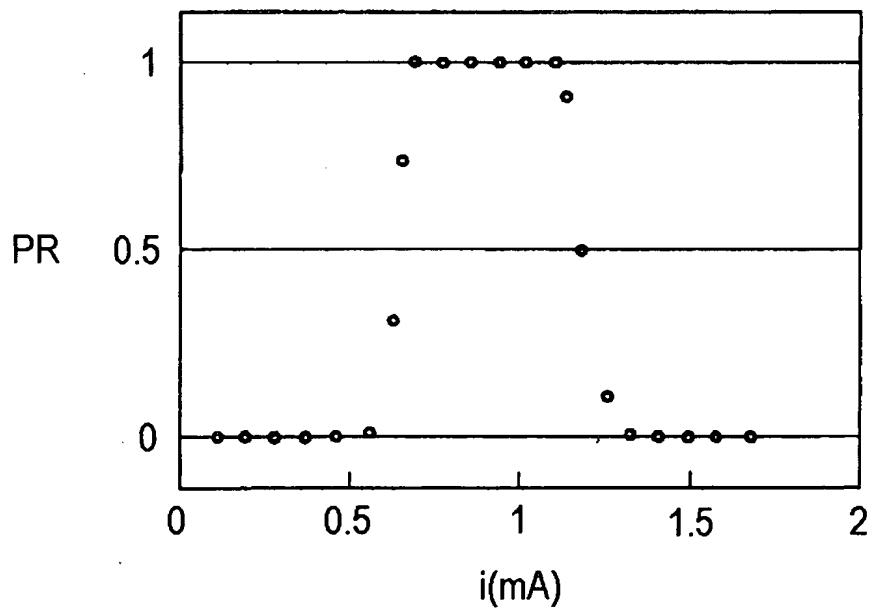
FIG.8**FIG.9**

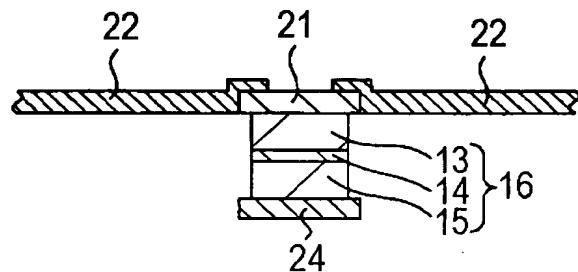
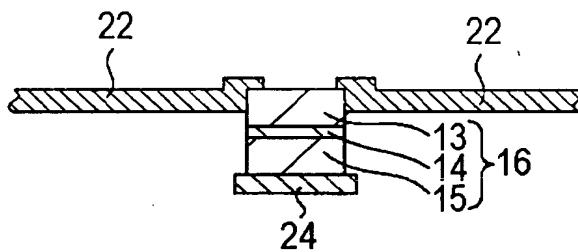
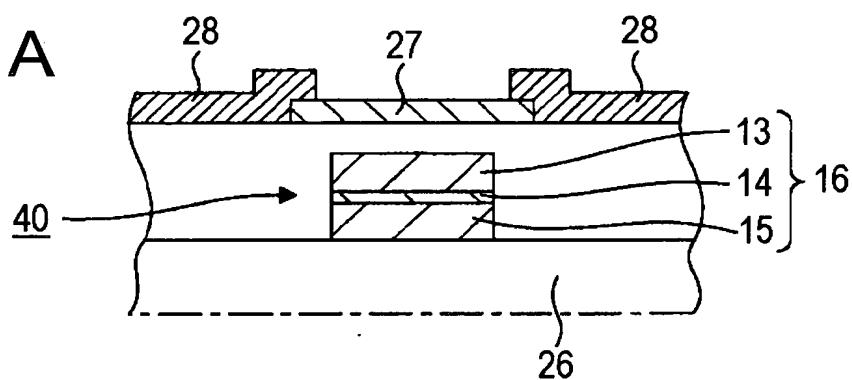
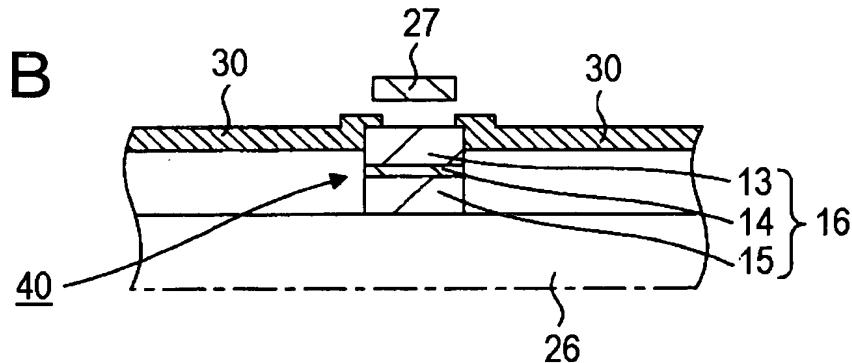
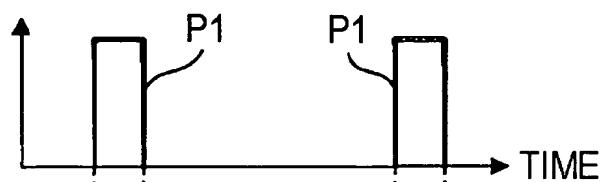
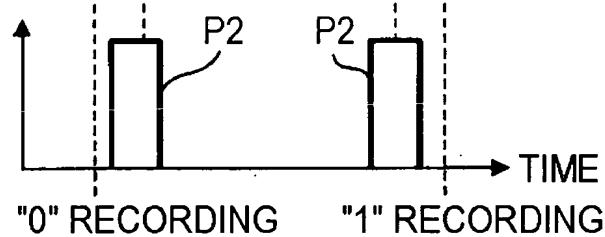
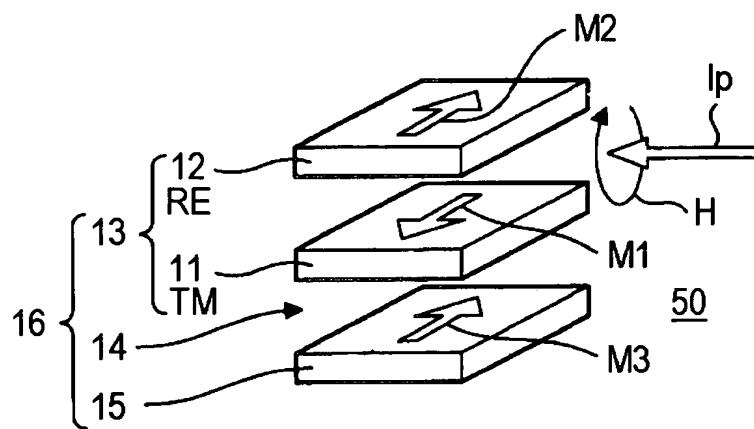
FIG.10A**FIG.10B****FIG.11A****FIG.11B**

FIG.12ACURRENT TO
RESISTANCE HEATER**FIG.12B**CURRENT TO
STORAGE LAYER**FIG.13**

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FIG.14

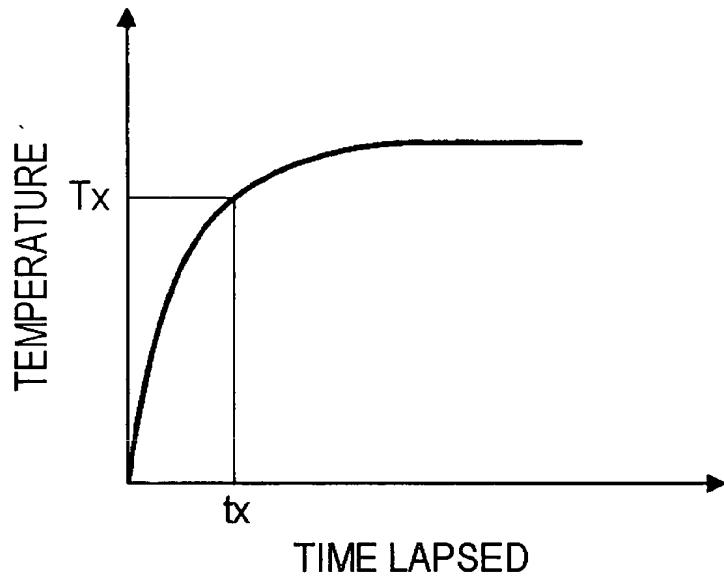


FIG.15

